

LINEAR TECHNOLOGY MATERIALS DECLARATION

(Engineering Calculation)

SOT-23

LT1460JCS3-10#TRMPBF

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TOTAL MASS (g): 0.013164

COMPONENT MATERIAL	VENDOR/INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL Pkg.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.000481	1000000	36258.46875		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu [HD]	Copper (Cu)	7440-50-8	0.003510	975000	26662.0625		
		Iron (Fe)	7439-89-6	0.000083	23000	6304.97460938		
		Phosphorus (P)	7723-14-0	0.000001	400	75.9635543823		
		Zinc (Zn)	7440-66-6	0.000006	1600	455.781311035		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-98-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead Frame Total:				0.003600	1000000	27348.75
		Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0
Exter. Plating Sn	7440-31-5			0.000227	1000000	17259.5253906		
External Plating Total:						0.000227	1000000	17259.5253906
Inter. Plating Ni	7440-02-0			0.000000	0	0		
Inter. Plating Ag	7440-22-4			0.000036	1000000	2734.68798828		
Internal Plating Total:						0.000036	1000000	2734.68798828
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000281	750000	21345.7578125		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000094	250000	7140.57421875		
		Die Attach Total:				0.000375	1000000	28486.3220312
		Encapsulation	MULTIAROMATIC RESIN BOND FREE	Resin (EP)		0.000488	8000	37070.2109375
				Bromine (Br)	40093-93-8	0.000000	0	0
Silica (SiO2)	60676-86-0			0.007485	890000	568587.1875		
Antimony Trioxide (Sb2O3)	1309-64-4			0.000000	0	0		
Metal Hydroxide				0.000421	50000	31980.65625		
Carbon Black (C)	1333-86-4			0.000017	2000	1291.38037109		
Encapsulation Total:						0.008411	1000000	638929.375
Bond Wire Estimated	AFW/TANAKA/Kn	Gold (Au)	7440-57-5	0.000034	1000000	2582.76074219		

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